



Docket No.: M4065.0239/P239
(PATENT)

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52402

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Larry Hillyer, et al. ✓

Application No.: 09/653,561 ✓

Group Art Unit: 2812

Filed: August 31, 2000 ✓

Examiner: Ha T. Nguyen

For: METHOD AND MATERIAL FOR
REMOVING ETCH RESIDUE FROM
HIGH ASPECT RATIO CONTACT
SURFACES ✓

REQUEST FOR EXTENSION OF TIME

Commissioner for Patents
Washington, DC 20231

RECEIVED
MAY 22 2002
TECHNOLOGY CENTER 2800

Dear Sir:

Applicant hereby petitions for a one month extension of time to and including May 17, 2002 to respond to the Office Action mailed January 17, 2002. Our check in the amount of \$110.00 covering the fee set forth in 37 C.F.R. §1.17(a)(1) is enclosed.

This petition is being filed in order to ensure copendency with application being filed concurrently herewith. In the event that a further petition for an extension of time is required to be submitted at this time, applicant hereby petitions under 37 C.F.R. §1.136(a) for an extension of time for as many months as are required to ensure that the above-identified application does not become abandoned.

The Commissioner is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper

hereafter filed in this application by this firm) to our Deposit Account No. 04-1073, under Order No. M4065.0239/P239. A duplicate copy of this paper is enclosed.

Dated: May 17, 2002

Respectfully submitted,

By  #33,082

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